

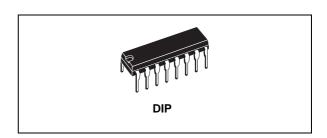
## PRESETTABLE BINARY UP/DOWN COUNTER

- MEDIUM SPEED OPERATION : 8 MHz (Typ.) at 10V
- SYNCHRONOUS INTERNAL CARRY PROPAGATION
- RESET AND PRESET CAPABILITY
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- QUIESCENT CURRENT SPECIF. UP TO 20V
- 5V, 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT I<sub>I</sub> = 100nA (MAX) AT V<sub>DD</sub> = 18V T<sub>A</sub> = 25°C
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B "STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"



HCF4516B is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP package.

It is a PRESETTABLE BINARY UP/DOWN COUNTER, consists of four synchronously clocked D-type flip-flops (with a gating structure to provide T-type flip-flop capability) connected as a counter. This counter can be cleared by a high level on the RESET line, and can be preset to any binary number present on the jam inputs by a high

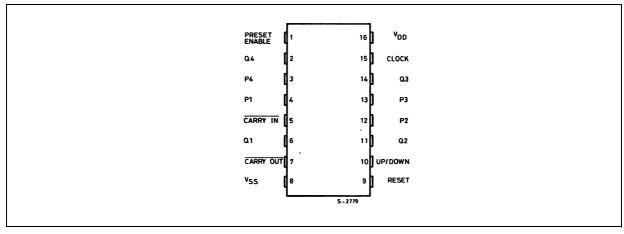


#### **ORDER CODES**

PACKAGE TUBE		T & R
DIP	HCF4516BEY	

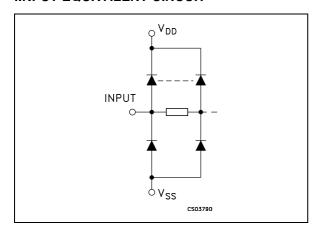
level on the PRESET ENABLE line. Synchronous cascading is accomplished by connecting all clock inputs in parallel and connecting the CARRY OUT of a less significant stage to the CARRY IN of a more significant stage. HCF4516B can be cascaded in the ripple mode by connecting all clock inputs in parallel and connecting the CARRY OUT to the clock of the next stage. If the UP/DOWN input changes during a terminal count, the CARRY OUT must be gated with the clock, and the UP/DOWN input must change while the clock is high. This method provides a clean clock signal to the subsequent counting stage.

#### **PIN CONNECTION**



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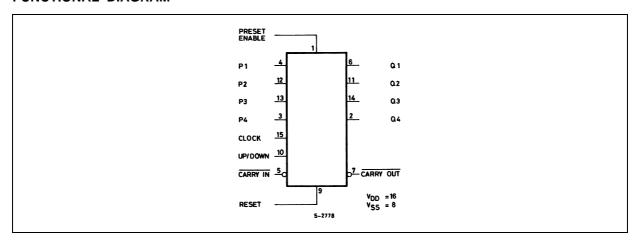
### **IINPUT EQUIVALENT CIRCUIT**



### **PIN DESCRIPTION**

PIN No	SYMBOL	NAME AND FUNCTION
1	PRESET ENABLE	Preset Enable Input
4, 12, 13, 3	P1 to P4	Inputs
6, 11, 14, 2	Q1 to Q4	Outputs
15	CLOCK	Clock Input
10	UP/DOWN	Up/Down Control Input
5	CARRY-IN	Carry Input
7	CARRY-OUT	Carry Output
9	RESET	Reset Input
8	$V_{SS}$	Negative Supply Voltage
16	$V_{DD}$	Positive Supply Voltage

### **FUNCTIONAL DIAGRAM**

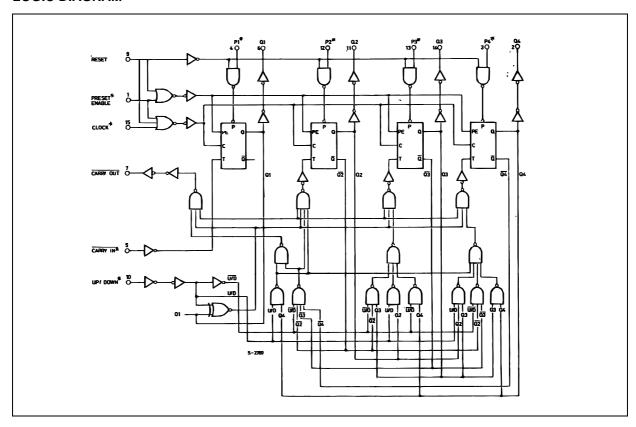


#### **TRUTH TABLE**

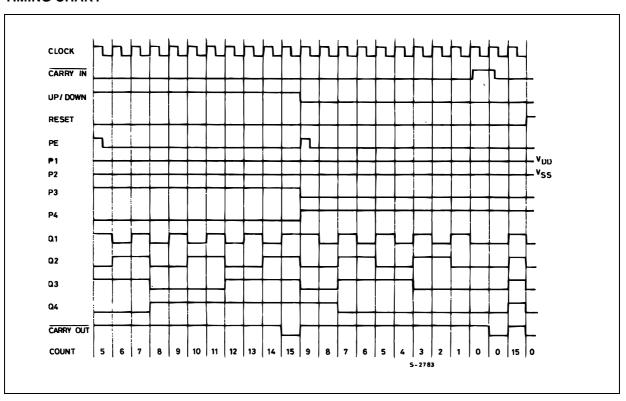
CL	CARRY-IN CI	UP/DOWN	PRESET ENABLE	RESET	ACTION
X	Н	Х	L	L	NO COUNT
	L	Н	L	L	COUNT UP
	L	L	L	L	COUNT DOWN
Х	Х	Х	Н	L	PRESET
Х	Х	Х	Х	Н	RESET

X : Don't Care

### **LOGIC DIAGRAM**



### **TIMING CHART**



### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	-0.5 to +22	V
V <sub>I</sub>	DC Input Voltage	-0.5 to V <sub>DD</sub> + 0.5	V
I	DC Input Current	± 10	mA
$P_{D}$	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T <sub>op</sub>	Operating Temperature	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V<sub>SS</sub> pin voltage.

### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	3 to 20	V
V <sub>I</sub>	Input Voltage	0 to V <sub>DD</sub>	V
T <sub>op</sub>	Operating Temperature	-55 to 125	°C

## **DC SPECIFICATIONS**

	Parameter		Test Con	dition		Value							
Symbol		Vı	v <sub>o</sub>	l <sub>o</sub>	V <sub>DD</sub>	Т	T <sub>A</sub> = 25°C		-40 to 85°C		-55 to 125°C		Unit
		(V)	(V)	(μ <b>A</b> )	(V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
ΙL	Quiescent Current	0/5			5		0.04	5		150		150	
		0/10			10		0.04	10		300		300	μA
		0/15			15		0.04	20		600		600	μΑ
		0/20			20		0.08	100		3000		3000	
V <sub>OH</sub>	High Level Output	0/5		<1	5	4.95			4.95		4.95		
	Voltage	0/10		<1	10	9.95			9.95		9.95		V
		0/15		<1	15	14.95			14.95		14.95		
$V_{OL}$	Low Level Output	5/0		<1	5		0.05			0.05		0.05	
Voltage	10/0		<1	10		0.05			0.05		0.05	V	
		15/0		<1	15		0.05			0.05		0.05	
$V_{IH}$	High Level Input		0.5/4.5	<1	5	3.5			3.5		3.5		V
	Voltage		1/9	<1	10	7			7		7		
			1.5/13.5	<1	15	11			11		11		
$V_{IL}$	Low Level Input		4.5/0.5	<1	5			1.5		1.5		1.5	
	Voltage		9/1	<1	10			3		3		3	V
			13.5/1.5	<1	15			4		4		4	
I <sub>OH</sub>	Output Drive	0/5	2.5	<1	5	-1.36	-3.2		-1.1		-1.1		
	Current	0/5	4.6	<1	5	-0.44	-1		-0.36		-0.36		mA
		0/10	9.5	<1	10	-1.1	-2.6		-0.9		-0.9		IIIA
		0/15	13.5	<1	15	-3.0	-6.8		-2.4		-2.4		
l <sub>OL</sub>	Output Sink	0/5	0.4	<1	5	0.44	1		0.36		0.36		
Current	Current	0/10	0.5	<1	10	1.1	2.6		0.9		0.9		mΑ
		0/15	1.5	<1	15	3.0	6.8		2.4		2.4		
II	Input Leakage Current	0/18	Any In	put	18		±10 <sup>-5</sup>	±0.1		±1		±1	μΑ
Cı	Input Capacitance		Any In	put		_	5	7.5	_				pF

The Noise Margin for both "1" and "0" level is: 1V min. with  $V_{DD}$ =5V, 2V min. with  $V_{DD}$ =10V, 2.5V min. with  $V_{DD}$ =15V

# $\textbf{DYNAMIC ELECTRICAL CHARACTERISTICS} \ (T_{amb} = 25^{\circ}\text{C}, \ \ C_{L} = 50 \text{pF}, \ R_{L} = 200 \text{K}\Omega, \ \ t_{r} = t_{f} = 20 \ \text{ns})$

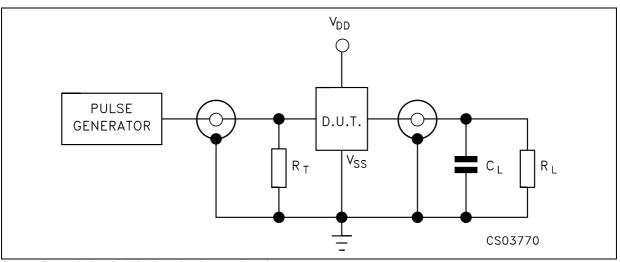
	Parameter		Test Condition			Value (*)		
Symbol		V <sub>DD</sub> (V)		Min.	Тур.	Max.		
t <sub>PHL</sub> t <sub>PLH</sub> Pr	Propagation Delay Time	5			200	400		
	Clock to Q Output	10			100	200	ns	
		15			75	150		
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Time	5			210	420		
	Preset or Reset to Q	10			105	210	ns	
	Output	15			80	160		
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Time	5			240	480		
	Clock to Carry Out	10			120	240	ns	
		15			90	180		
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Time	5			125	250		
	Carry in to Carry Out	10			60	120	ns	
		15			50	100		
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Time	5			320	640		
	Preset or Reset to Carry	10			160	320	ns	
	Out	15			125	250		
t <sub>THL</sub> t <sub>TLH</sub>	Transition Time	5			100	200		
		10			50	100	ns	
		15			40	80		
$f_{MAX}$	Maximum Clock	5		2	4			
	Frequency	10		4	8		MHz	
		15		5.5	11			
$t_{W}$	Clock Pulse Width	5		150				
		10		75			ns	
		15		60				
t <sub>REM</sub> (1)	Preset Enable or Reset	5		150				
	Removal Time	10		80			ns	
		15		60				
$t_r$ , $t_f$ <sup>(2)</sup>	Clock Rise or Fall Time	5				15		
		10				5	μs	
		15				5		
t <sub>setup</sub>	Carry in Setup Time	5		130				
		10		60			ns	
		15		45				
t <sub>setup</sub>	Up/Down Setup Time	5		360				
		10		160			ns	
		15		110				
$t_{W}$	Preset Enable or Reset	5		220				
	Pulse Width	10		100			ns	
		15		75				

<sup>(\*)</sup> Typical temperature coefficient for all V<sub>DD</sub> value is 0.3 %/°C.

(1) Time required after the falling edge of the reset or preset enable inputs before the rising edge of the clock will trigger the counter (similar to setup time)

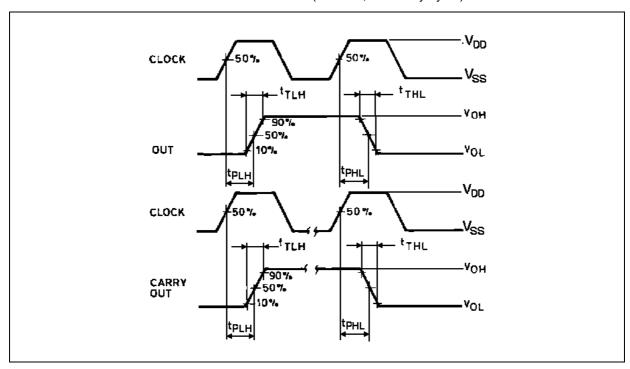
(2) If more than unit is cascaded in the parallel clocked application, trCL should be made less than or equal to the sum of the fixed propagation delay at 15pF and the transition time of the carry output driving stage for the estimated capacitive load.

#### **TEST CIRCUIT**

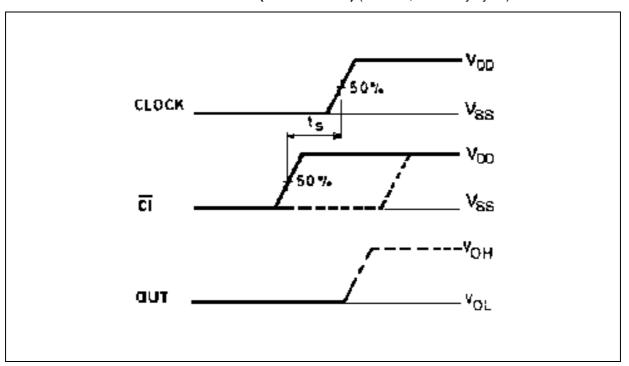


 $C_L$  = 50pF or equivalent (includes jig and probe capacitance)  $R_L$  = 200KΩ  $R_T$  =  $Z_{OUT}$  of pulse generator (typically 50Ω)

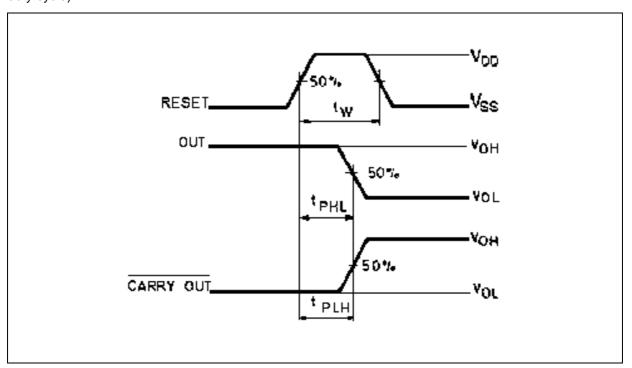
## WAVEFORM 1: PROPAGATION DELAY TIMES (f=1MHz; 50% duty cycle)



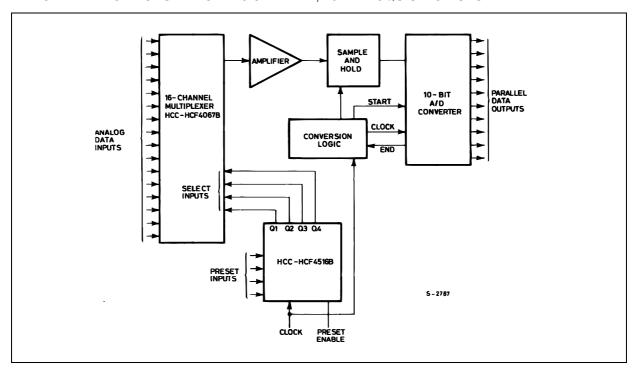
WAVEFORM 2: MINIMUM SETUP TIME (CI TO CLOCK) (f=1MHz; 50% duty cycle)



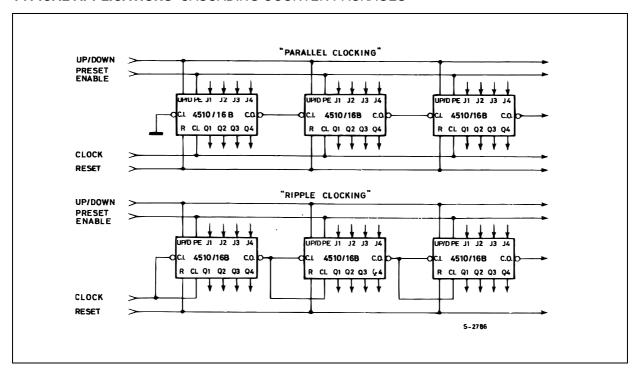
**WAVEFORM 3: PROPAGATION DELAY TIMES, MINIMUM RESET PULSE WIDTH** (f=1MHz; 50% duty cycle)



### TYPICAL APPLICATIONS TIPICAL 16 CHANNEL, 10 BIT ACQUISITION SYSTEM

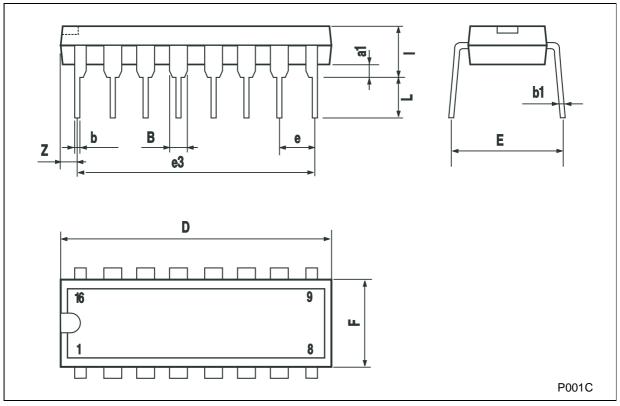


#### TYPICAL APPLICATIONS CASCADING COUNTER PACKAGES



# Plastic DIP-16 (0.25) MECHANICAL DATA

DIM.		mm.				
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
В	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
еЗ		17.78			0.700	
F			7.1			0.280
1			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



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